

# NUD4700

## LED Shunt

The NUD4700 is an electronic shunt which provides a current bypass in the case of a single LED going into open circuit. LEDs are by nature quite fragile when subjected to transients and surge conditions. There are also many cases where high reliability of the LED lighting must be maintained such as headlights, lighthouses, bridges, aircraft, runways and so forth. In these cases the low cost addition of the NUD4700 will provide full assurance that an entire string of LEDs will not extinguish should one LED fail. NUD4700 is also applicable to other loads where circuit continuity is required. This device is designed to be used with 1 W LEDs (nominally 350 mA @ 3 V).

### Features

- A Simple Two Terminal Device
- Automatically Resets Itself if the LED Heals Itself or is Replaced
- ON-State Voltage Typically 1 V
- OFF-State Current less than 250  $\mu$ A
- This is a Pb-Free Device

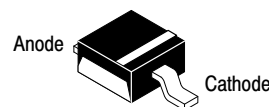
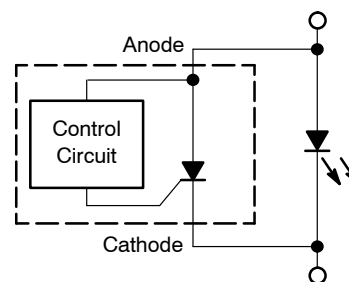
### Typical Applications

- LEDs where Preventive Maintenance is Non Practical
- LED Headlights
- LEDs with High Reliability Requirements
- Crowbar Protection for Open Circuit Conditions
- Overvoltage Protection for Sensitive Circuits



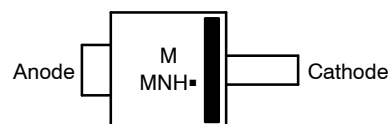
**ON Semiconductor®**

<http://onsemi.com>



**POWERMITE®  
CASE 457  
PLASTIC**

### MARKING DIAGRAM



M = Date Code  
MNH = Device Code  
▪ = Pb-Free Package

### PIN FUNCTION DESCRIPTION

Pin	Description
Anode	Positive Input Voltage to the Device
Cathode	Negative Input Voltage to the Device

### ORDERING INFORMATION

Device	Package	Shipping†
NUD4700SNT1G	POWERMITE (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# NUD4700

**MAXIMUM RATINGS** (Maximum ratings are those, that, if exceeded, may cause damage to the device. Electrical Characteristics are not guaranteed over this range)

Rating	Symbol	Value	Unit
Peak Repetitive Off State Voltage (Anode to Cathode)	$V_{DM}$	-0.3 to 10	V
Average On-State Current, ( $T_A = 25^\circ\text{C}$ ), (Note 1) (Note 2)	$I_{T(AVG)}$	1.3 0.376	A
Thermal Resistance, Junction-to-Air (Note 1) (Note 2)	$Q_{JA}$	80 277	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Lead	$Q_{JL}$	35	$^\circ\text{C}/\text{W}$
Power Dissipation ( $T_A = 25^\circ\text{C}$ ) (Note 1) (Note 2)	$P_{MAX}$	1.56 0.45	W
Operating Temperature Range	$T_J$	-40 to 150	$^\circ\text{C}$
Non-Operating Temperature Range	$T_J$	150	$^\circ\text{C}$
Lead Temperature, Soldering (10 Sec)	$T_L$	260	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Mounted onto a 1" x 1" square copper pad.

Normally this device would be mounted on the same copper heat sink and adjacent to the LED. If the LED were to go open, then the NUD4700 shunt would now dissipate the power using the same copper heat sink. Since the NUD4700 has a voltage that is nominally 30% of the LED, then the power dissipation would be easily handled by the same heat sink as the LED.

2. Device mounted on minimum copper pad.

## ELECTRICAL CHARACTERISTICS (Unless otherwise noted: $T_A = 25^\circ\text{C}$ )

Characteristics	Symbol	Min	Typ	Max	Unit
Off-State Current ( $V_{Anode} = 5\text{ V}$ )	$I_{LEAK}$	-	100	250	$\mu\text{A}$
Breakdown Voltage ( $I_{BR} = 1\text{ mA}$ )	$V_{(BR)}$	5.5	-	7.5	V
Holding Current ( $V_{Anode} = 10\text{ V}$ , $I_{initial} = 100\text{ mA}$ )	$I_H$	-	6.0	12	mA
Latching Current ( $V_{Anode} = 10\text{ V}$ )	$I_L$	-	35	70	mA
On-State Voltage ( $I_T = 0.350\text{ A}$ ) ( $I_T = 0.750\text{ A}$ ) ( $I_T = 1.0\text{ A}$ )	$V_T$	- - -	1.0 1.0 1.0	1.2 - -	V

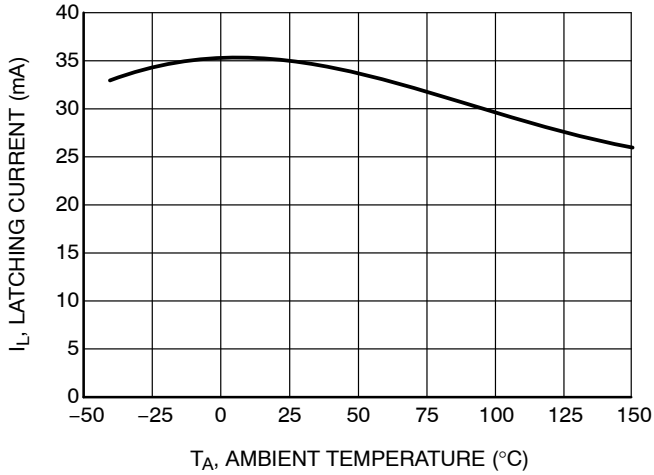
## DYNAMIC CHARACTERISTICS

Critical Rate-of-Rise of Off State Voltage ( $V_{pk} = \text{Rated } V_{(BR)}$ , $T_J = 125^\circ\text{C}$ , Exponential Method)	dV/dt	250	-	-	V/ $\mu\text{s}$
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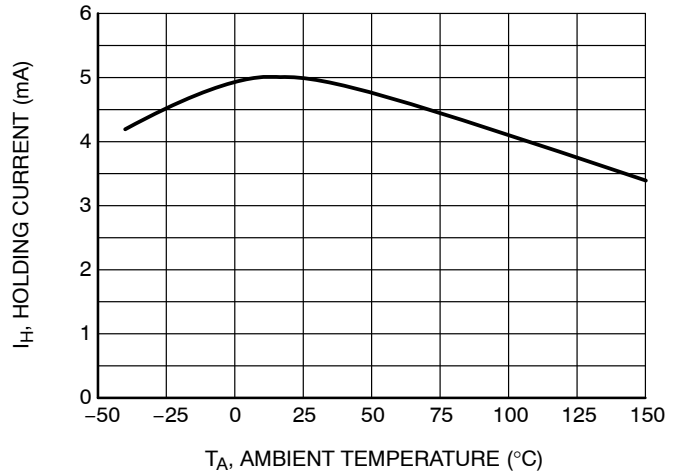
# NUD4700

## TYPICAL PERFORMANCE CURVES

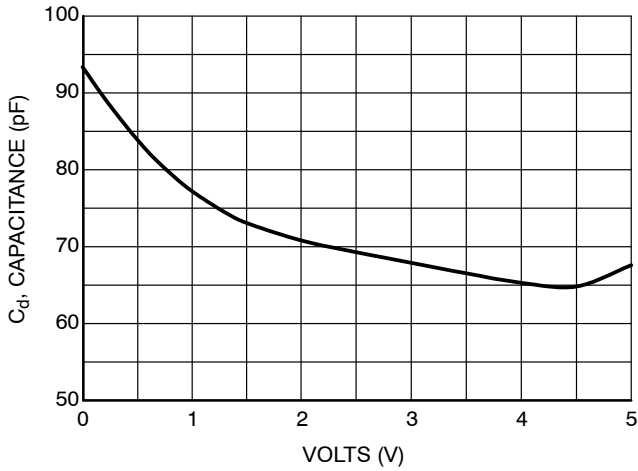
( $T_A = 25^\circ\text{C}$  unless otherwise noted)



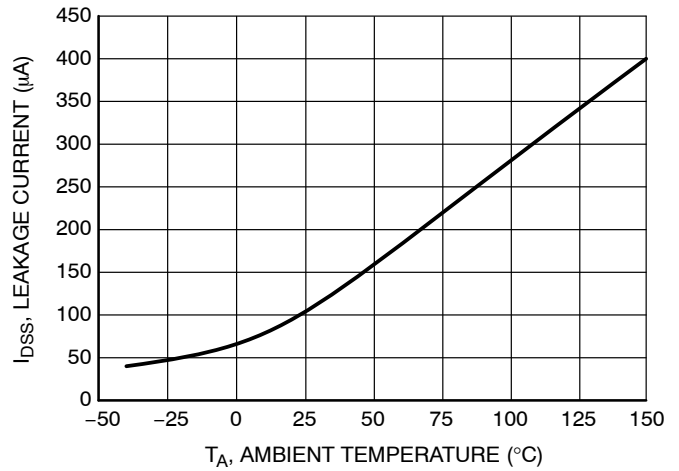
**Figure 1. Latching Current vs Temperature**



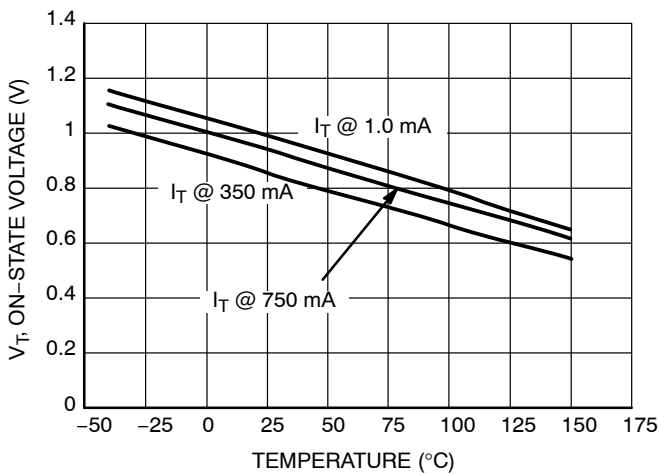
**Figure 2. Holding Current vs Temperature**



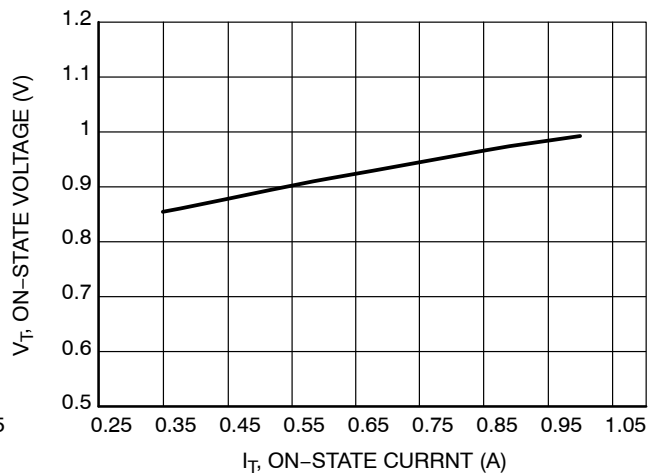
**Figure 3. Capacitance vs Voltage**



**Figure 4. Leakage Current vs Temperature**



**Figure 5. On-State Voltage vs. Temperature**



**Figure 6. On-State Voltage vs. On-State Current ( $I_T$ ) at  $25^\circ\text{C}$**

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## TYPICAL APPLICATION CIRCUIT

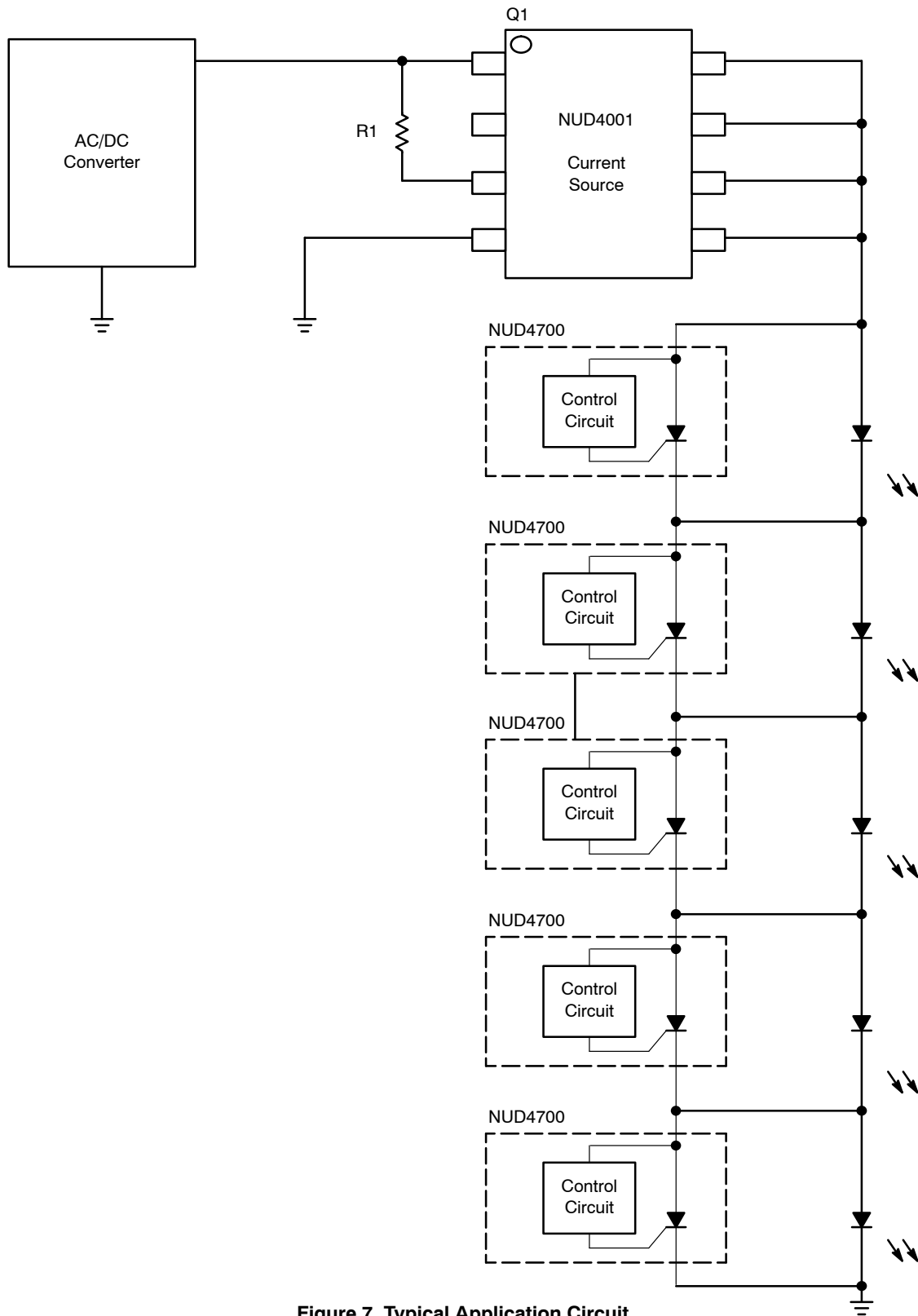


Figure 7. Typical Application Circuit

# NUD4700

## TYPICAL OPERATION WAVEFORMS

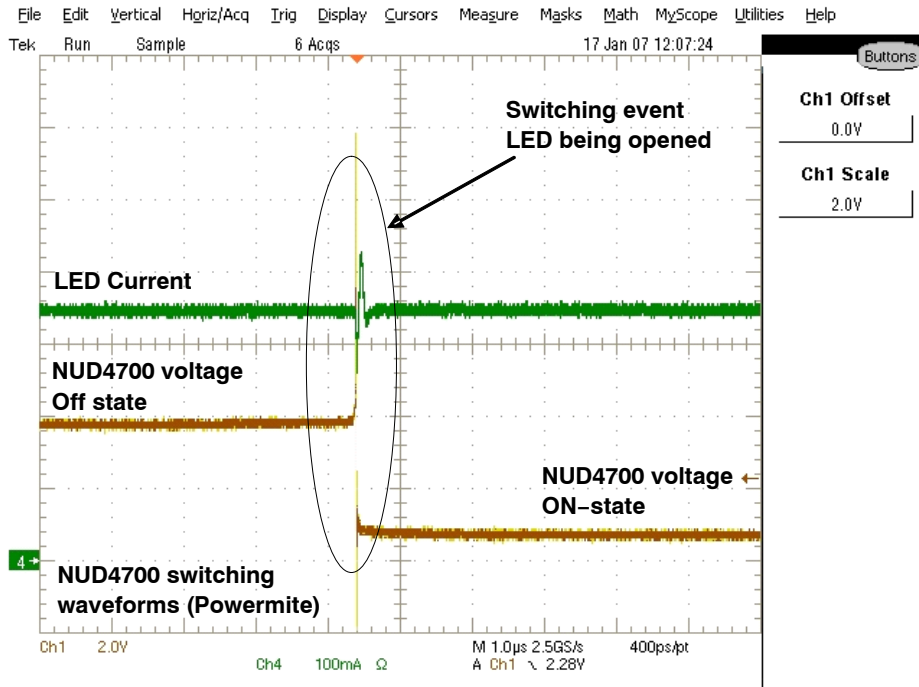


Figure 8. NUD4700 Switching Waveforms

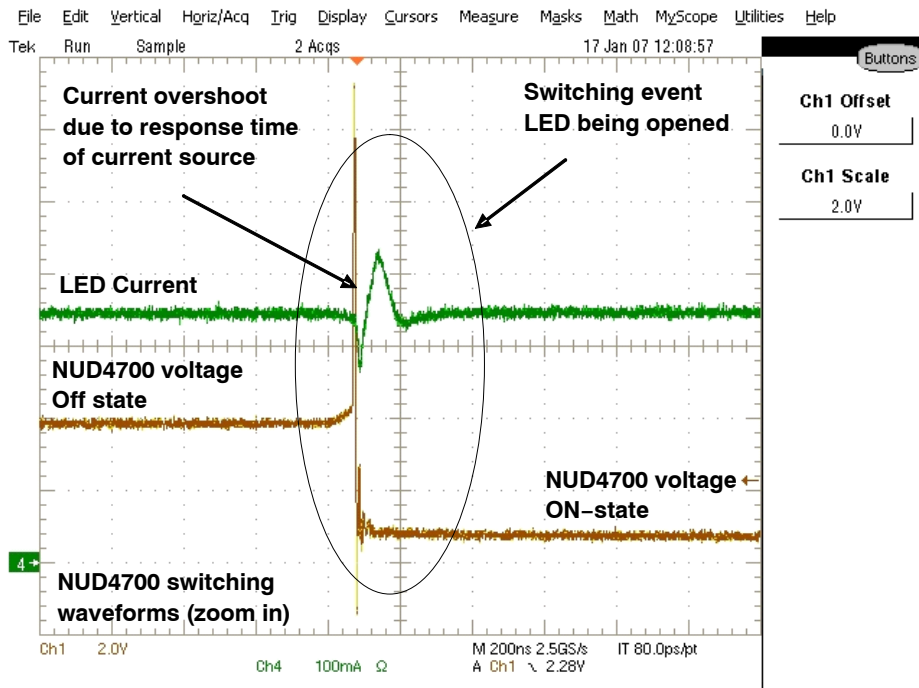
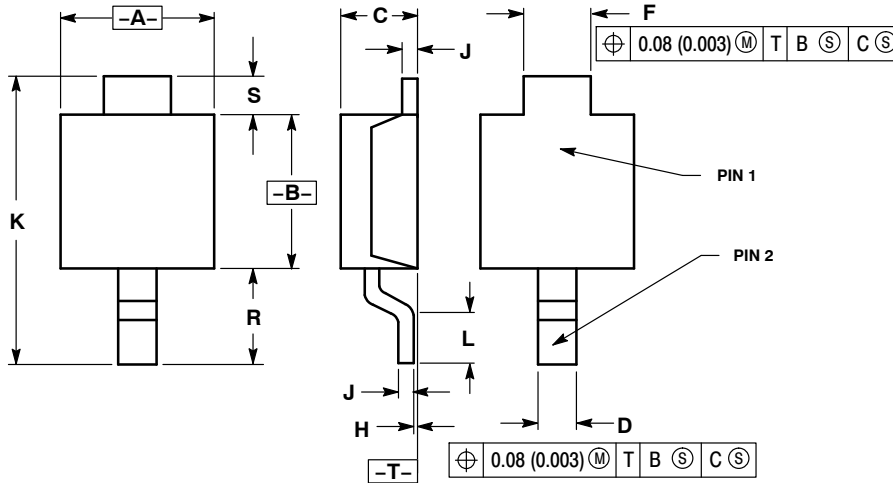


Figure 9. Zoom in of Figure 8

# NUD4700

## PACKAGE DIMENSIONS

POWERMITE  
CASE 457-04  
ISSUE E

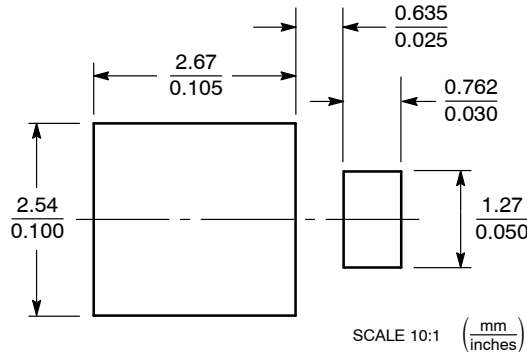


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.75	2.05	0.069	0.081
B	1.75	2.18	0.069	0.086
C	0.85	1.15	0.033	0.045
D	0.40	0.69	0.016	0.027
F	0.70	1.00	0.028	0.039
H	-0.05	+0.10	-0.002	+0.004
J	0.10	0.25	0.004	0.010
K	3.60	3.90	0.142	0.154
L	0.50	0.80	0.020	0.031
R	1.20	1.50	0.047	0.059
S	0.50 REF		0.019 REF	

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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